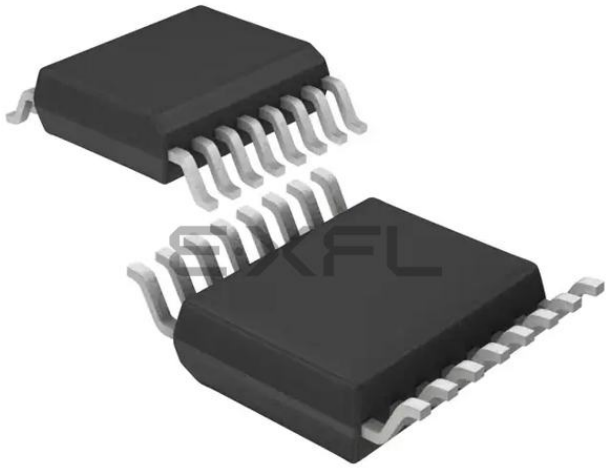

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	S08
Core Size	8-Bit
Speed	40MHz
Connectivity	I²C, LINbus, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	13
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	16-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	16-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mc9s08sh16vtg

Chapter 5
Resets, Interrupts, and General System Control

Chapter 6
Parallel Input/Output Control

Chapter 12
Modulo Timer (S08MTIMV1)

Chapter 13
Real-Time Counter (S08RTCV1)

4.4 RAM

The MC9S08SH32 Series includes static RAM. The locations in RAM below 0x0100 can be accessed using the more efficient direct addressing mode, and any single bit in this area can be accessed with the bit manipulation instructions (BCLR, BSET, BRCLR, and BRSET). Locating the most frequently accessed program variables in this area of RAM is preferred.

The RAM retains data when the MCU is in low-power wait, stop2, or stop3 mode. At power-on the contents of RAM are uninitialized. RAM data is unaffected by any reset provided that the supply voltage does not drop below the minimum value for RAM retention (V_{RAM}).

For compatibility with M68HC05 MCUs, the HCS08 resets the stack pointer to 0x00FF. In the MC9S08SH32 Series, it is usually best to reinitialize the stack pointer to the top of the RAM so the direct page RAM can be used for frequently accessed RAM variables and bit-addressable program variables. Include the following 2-instruction sequence in your reset initialization routine (where RamLast is equated to the highest address of the RAM in the Freescale Semiconductor-provided equate file).

```
LDHX    #RamLast+1    ;point one past RAM
TXS                   ;SP<-(H:X-1)
```

When security is enabled, the RAM is considered a secure memory resource and is not accessible through BDM or through code executing from non-secure memory. See Section 4.6, “Security”, for a detailed description of the security feature.

4.5 FLASH

The FLASH memory is intended primarily for program storage. In-circuit programming allows the operating program to be loaded into the FLASH memory after final assembly of the application product. It is possible to program the entire array through the single-wire background debug interface. Because no special voltages are needed for FLASH erase and programming operations, in-application programming is also possible through other software-controlled communication paths. For a more detailed discussion of in-circuit and in-application programming, refer to the *HCS08 Family Reference Manual, Volume I,* Freescale Semiconductor document order number HCS08RMv1/D.

The first byte of a series of sequential bytes being programmed in burst mode will take the same amount of time to program as a byte programmed in standard mode. Subsequent bytes will program in the burst program time provided that the conditions above are met. In the case the next sequential address is the beginning of a new row, the program time for that byte will be the standard time instead of the burst time. This is because the high voltage to the array must be disabled and then enabled again. If a new burst command has not been queued before the current command completes, then the charge pump will be disabled and high voltage removed from the array.

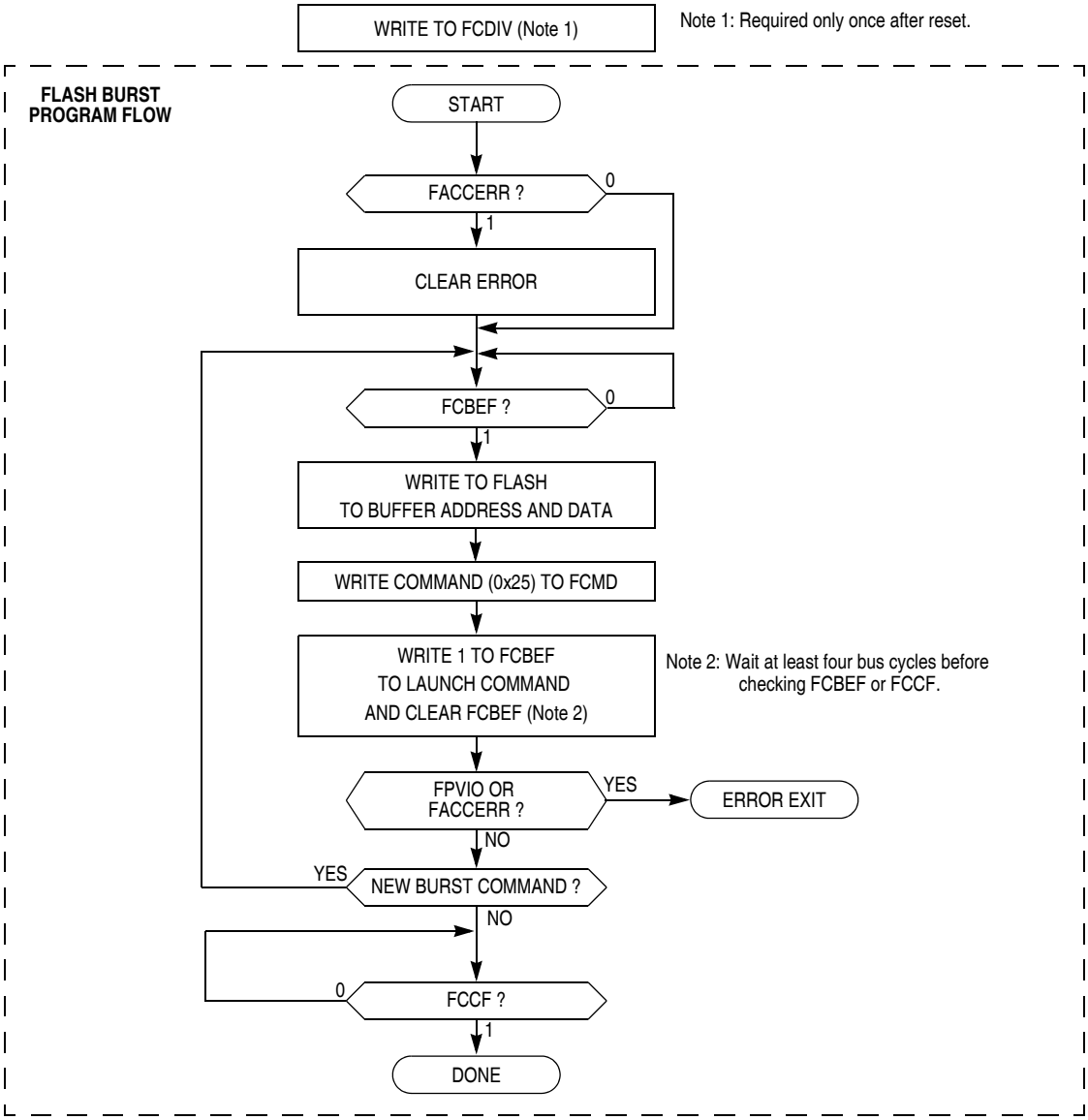

Figure 4-3. FLASH Burst Program Flowchart

control registers (FOPT, FPROT) at reset. There is also an 8-byte comparison key in FLASH memory. Refer to Table 4-3 and Table 4-4 for the absolute address assignments for all FLASH registers. This section refers to registers and control bits only by their names. A Freescale Semiconductor-provided equate or header file normally is used to translate these names into the appropriate absolute addresses.

4.7.1 FLASH Clock Divider Register (FCDIV)

Bit 7 of this register is a read-only flag. Bits 6:0 may be read at any time but can be written only one time. Before any erase or programming operations are possible, write to this register to set the frequency of the clock for the nonvolatile memory system within acceptable limits.

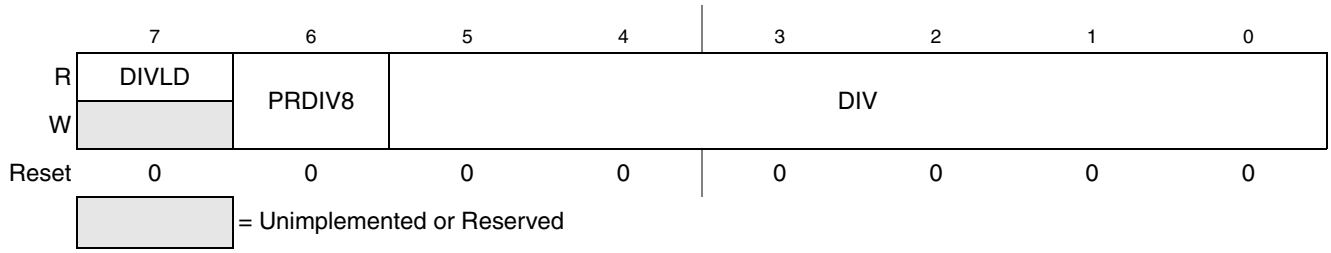

Figure 4-5. FLASH Clock Divider Register (FCDIV)

Table 4-6. FCDIV Register Field Descriptions

Field	Description
7 DIVLD	**Divisor Loaded Status Flag** — When set, this read-only status flag indicates that the FCDIV register has been written since reset. Reset clears this bit and the first write to this register causes this bit to become set regardless of the data written. 0 FCDIV has not been written since reset; erase and program operations disabled for FLASH. 1 FCDIV has been written since reset; erase and program operations enabled for FLASH.
6 PRDIV8	**Prescale (Divide) FLASH Clock by 8** 0 Clock input to the FLASH clock divider is the bus rate clock. 1 Clock input to the FLASH clock divider is the bus rate clock divided by 8.
5:0 DIV	**Divisor for FLASH Clock Divider** — The FLASH clock divider divides the bus rate clock (or the bus rate clock divided by 8 if PRDIV8 = 1) by the value in the 6-bit DIV field plus one. The resulting frequency of the internal FLASH clock must fall within the range of 200 kHz to 150 kHz for proper FLASH operations. Program/Erase timing pulses are one cycle of this internal FLASH clock which corresponds to a range of 5 μs to 6.7 μs. The automated programming logic uses an integer number of these pulses to complete an erase or program operation. See Equation 4-1 and Equation 4-2.

$$\text{if PRDIV8 = 0 — } f_{FCLK} = f_{Bus} \div (\text{DIV} + 1) \qquad \textit{Eqn. 4-1}$$

$$\text{if PRDIV8 = 1 — } f_{FCLK} = f_{Bus} \div (8 \times (\text{DIV} + 1)) \qquad \textit{Eqn. 4-2}$$

Table 4-7 shows the appropriate values for PRDIV8 and DIV for selected bus frequencies.

Table 4-11. FPROT Register Field Descriptions

Field	Description
7:1 FPS	**FLASH Protect Select Bits** — When FPDIS = 0, this 7-bit field determines the ending address of unprotected FLASH locations at the high address end of the FLASH. Protected FLASH locations cannot be erased or programmed.
0 FPDIS	**FLASH Protection Disable** 0 FLASH block specified by [7:1] is block protected (program and erase not allowed). 1 No FLASH block is protected.

4.7.5 FLASH Status Register (FSTAT)

	7	6	5	4	3	2	1	0
R	FCBEF	FCCF	FPVIOL	FACCERR	0	FBLANK	0	0
W								
Reset	1	1	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 4-9. FLASH Status Register (FSTAT)

Table 4-12. FSTAT Register Field Descriptions

Field	Description
7 FCBEF	**FLASH Command Buffer Empty Flag** — The FCBEF bit is used to launch commands. It also indicates that the command buffer is empty so that a new command sequence can be executed when performing burst programming. The FCBEF bit is cleared by writing a 1 to it or when a burst program command is transferred to the array for programming. Only burst program commands can be buffered. 0 Command buffer is full (not ready for additional commands). 1 A new burst program command can be written to the command buffer.
6 FCCF	**FLASH Command Complete Flag** — FCCF is set automatically when the command buffer is empty and no command is being processed. FCCF is cleared automatically when a new command is started (by writing 1 to FCBEF to register a command). Writing to FCCF has no meaning or effect. 0 Command in progress 1 All commands complete
5 FPVIOL	**Protection Violation Flag** — FPVIOL is set automatically when a command is written that attempts to erase or program a location in a protected block (the erroneous command is ignored). FPVIOL is cleared by writing a 1 to FPVIOL. 0 No protection violation. 1 An attempt was made to erase or program a protected location.

5.7.5 System Options Register 2 (SOPT2)

This high page register contains bits to configure MCU specific features on the MC9S08SH32 Series devices.

	7	6	5	4	3	2	1	0
R	COPCLKS[1]	COPW[1]	0	ACIC	T2CH1PS	T2CH0PS	T1CH1PS	T1CH0PS
W								
Reset:	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 5-6. System Options Register 2 (SOPT2)

1 This bit can be written only one time after reset. Additional writes are ignored.

Table 5-7. SOPT2 Register Field Descriptions

Field	Description
7 COPCLKS	**COP Watchdog Clock Select** — This write-once bit selects the clock source of the COP watchdog. 0 Internal 1-kHz clock is source to COP. 1 Bus clock is source to COP.
6 COPW	**COP Window** — This write-once bit selects the COP operation mode. When set, the 0x55-0xAA write sequence to the SRS register must occur in the last 25% of the selected period. Any write to the SRS register during the first 75% of the selected period will reset the MCU. 0 Normal COP operation 1 Window COP operation (only if COPCLKS = 1)
4 ACIC	**Analog Comparator to Input Capture Enable**— This bit connects the output of ACMP to TPM1 input channel 0. 0 ACMP output not connected to TPM1 input channel 0. 1 ACMP output connected to TPM1 input channel 0.
3 T2CH1PS	**TPM2CH1 Pin Select**— This selects the location of the TPM2CH1 pin of the TPM2 module. 0 TPM2CH1 on PTB4. 1 TPM2CH1 on PTA7.
2 T2CH0PS	**TPM2CH0 Pin Select**— This bit selects the location of the TPM2CH0 pin of the TPM2 module. 0 TPM2CH0 on PTA1. 1 TPM2CH0 on PTA6.
1 T1CH1PS	**TPM1CH1 Pin Select**— This selects the location of the TPM1CH1 pin of the TPM1 module. 0 TPM1CH1 on PTB5. 1 TPM1CH1 on PTC1.
0 T1CH0PS	**TPM1CH0 Pin Select**— This bit selects the location of the TPM1CH0 pin of the TPM1 module. 0 TPM1CH0 on PTA0. 1 TPM1CH0 on PTC0.

6.4 Pin Interrupts

Port A[3:0] and port B[3:0] pins can be configured as external interrupt inputs and as an external means of waking the MCU from stop3 or wait low-power modes.

The block diagram for the pin interrupts is shown Figure 6-2.

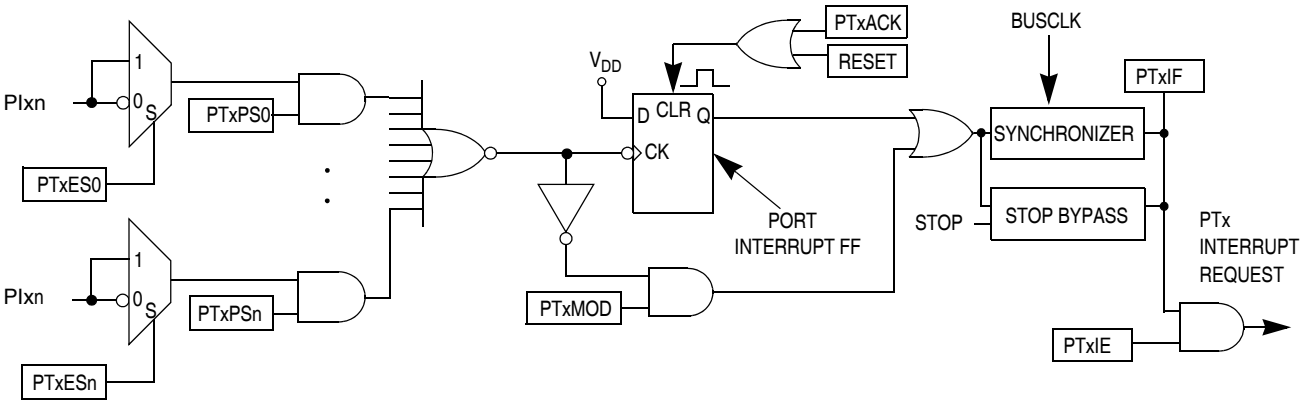

Figure 6-2. Pin Interrupt Block Diagram

Writing to the PTxPSn bits in the port interrupt pin enable register (PTxPS) independently enables or disables each port pin interrupt. Each port can be configured as edge sensitive or edge and level sensitive based on the PTxMOD bit in the port interrupt status and control register (PTxSC). Edge sensitivity can be software programmed to be either falling or rising; the level can be either low or high. The polarity of the edge or edge and level sensitivity is selected using the PTxESn bits in the port interrupt edge select register (PTxES).

Synchronous logic is used to detect edges. Prior to detecting an edge, enabled pin interrupt inputs must be at the deasserted logic level. A falling edge is detected when an enabled port input signal is seen as a logic 1 (the deasserted level) during one bus cycle and then a logic 0 (the asserted level) during the next cycle. A rising edge is detected when the input signal is seen as a logic 0 during one bus cycle and then a logic 1 during the next cycle.

6.4.1 Edge-Only Sensitivity

A valid edge on an enabled pin interrupt sets PTxIF in PTxSC. If PTxIE in PTxSC is set, an interrupt request is presented to the CPU. To clear PTxIF, write a 1 to PTxACK in PTxSC.

NOTE

If a pin is enabled for interrupt on edge-sensitive only, a falling (or rising) edge on the pin does not latch an interrupt request if another pin interrupt is already asserted.

To prevent losing an interrupt request on one pin because another pin is asserted, software can disable the asserted pin interrupt while having the unasserted pin interrupt enabled. The asserted status of a pin is reflected by its associated I/O general purpose data register.

6.6.1 Port A Registers

Port A is controlled by the registers listed below.

The pins PTA4 and PTA5 are unique. PTA4 is output-only, so the control bits for the input function will not have any effect on this pin. PTA5, when configured as an output, is open drain.

NOTE

This PTA5 pin does not contain a clamp diode to V_{DD} and should not be driven above V_{DD}.

When the internal pullup device is enabled on PTA5 when used as an input or open drain output the voltage measured on PTA5 will not be pulled to V_{DD}. The internal gates connected to this pin are pulled to V_{DD}. If the PTA5 pin is required to drive to a V_{DD} level an external pullup should be used.

6.6.1.1 Port A Data Register (PTAD)

	7	6	5	4	3	2	1	0
R W	PTAD7	PTAD6	PTAD5	PTAD4[1]	PTAD3	PTAD2	PTAD1	PTAD0
Reset:	0	0	0	0	0	0	0	0

Figure 6-3. Port A Data Register (PTAD)

1 Reads of bit PTAD4 always return the contents of PTAD4, regardless of the value stored in bit PTADD4.

Table 6-2. PTAD Register Field Descriptions

Field	Description
7:0 PTAD[7:0]	**Port A Data Register Bits** — For port A pins that are inputs, reads return the logic level on the pin. For port A pins that are configured as outputs, reads return the last value written to this register. Writes are latched into all bits of this register. For port A pins that are configured as outputs, the logic level is driven out the corresponding MCU pin. Reset forces PTAD to all 0s, but these 0s are not driven out the corresponding pins because reset also configures all port pins as high-impedance inputs with pull-ups/pull-downs disabled.

are too fast, then the clock must be divided to the appropriate frequency. This divider is specified by the ADIV bits and can be divide-by 1, 2, 4, or 8.

9.4.2 Input Select and Pin Control

The pin control registers (APCTL3, APCTL2, and APCTL1) are used to disable the I/O port control of the pins used as analog inputs.When a pin control register bit is set, the following conditions are forced for the associated MCU pin:

- The output buffer is forced to its high impedance state.
- The input buffer is disabled. A read of the I/O port returns a zero for any pin with its input buffer disabled.
- The pullup is disabled.

9.4.3 Hardware Trigger

The ADC module has a selectable asynchronous hardware conversion trigger, ADHWT, that is enabled when the ADTRG bit is set. This source is not available on all MCUs. Consult the module introduction for information on the ADHWT source specific to this MCU.

When ADHWT source is available and hardware trigger is enabled (ADTRG=1), a conversion is initiated on the rising edge of ADHWT. If a conversion is in progress when a rising edge occurs, the rising edge is ignored. In continuous convert configuration, only the initial rising edge to launch continuous conversions is observed. The hardware trigger function operates in conjunction with any of the conversion modes and configurations.

9.4.4 Conversion Control

Conversions can be performed in either 10-bit mode or 8-bit mode as determined by the MODE bits. Conversions can be initiated by either a software or hardware trigger. In addition, the ADC module can be configured for low power operation, long sample time, continuous conversion, and automatic compare of the conversion result to a software determined compare value.

9.4.4.1 Initiating Conversions

A conversion is initiated:

- Following a write to ADCSC1 (with ADCH bits not all 1s) if software triggered operation is selected.
- Following a hardware trigger (ADHWT) event if hardware triggered operation is selected.
- Following the transfer of the result to the data registers when continuous conversion is enabled.

If continuous conversions are enabled a new conversion is automatically initiated after the completion of the current conversion. In software triggered operation, continuous conversions begin after ADCSC1 is written and continue until aborted. In hardware triggered operation, continuous conversions begin after a hardware trigger event and continue until aborted.

10.6.2 Address Detect Interrupt

When the calling address matches the programmed slave address (IIC address register) or when the GCAEN bit is set and a general call is received, the IAAS bit in the status register is set. The CPU is interrupted, provided the IICIE is set. The CPU must check the SRW bit and set its Tx mode accordingly.

10.6.3 Arbitration Lost Interrupt

The IIC is a true multi-master bus that allows more than one master to be connected on it. If two or more masters try to control the bus at the same time, the relative priority of the contending masters is determined by a data arbitration procedure. The IIC module asserts this interrupt when it loses the data arbitration process and the ARBL bit in the status register is set.

Arbitration is lost in the following circumstances:

- SDA sampled as a low when the master drives a high during an address or data transmit cycle.
- SDA sampled as a low when the master drives a high during the acknowledge bit of a data receive cycle.
- A start cycle is attempted when the bus is busy.
- A repeated start cycle is requested in slave mode.
- A stop condition is detected when the master did not request it.

This bit must be cleared by software writing a 1 to it.

11.1.2 Features

Key features of the ICS module follow. For device specific information, refer to the ICS Characteristics in the Electricals section of the documentation.

- Frequency-locked loop (FLL) is trimmable for accuracy
  - 0.1% resolution using internal 32kHz reference
  - 2% deviation over voltage and temperature using internal 32kHz reference
- Internal or external reference clocks up to 5MHz can be used to control the FLL
  - 3 bit select for reference divider is provided
- Internal reference clock has 9 trim bits available
- Internal or external reference clocks can be selected as the clock source for the MCU
- Whichever clock is selected as the source can be divided down
  - 2 bit select for clock divider is provided
    - Allowable dividers are: 1, 2, 4, 8
    - BDC clock is provided as a constant divide by 2 of the DCO output
- Control signals for a low power oscillator as the external reference clock are provided
  - HGO, RANGE, EREFS, ERCLKEN, EREFSTEN
- FLL Engaged Internal mode is automatically selected out of reset

11.1.3 Block Diagram

Figure 11-2 is the ICS block diagram.

12.1.4 Block Diagram

The block diagram for the modulo timer module is shown Figure 12-2.

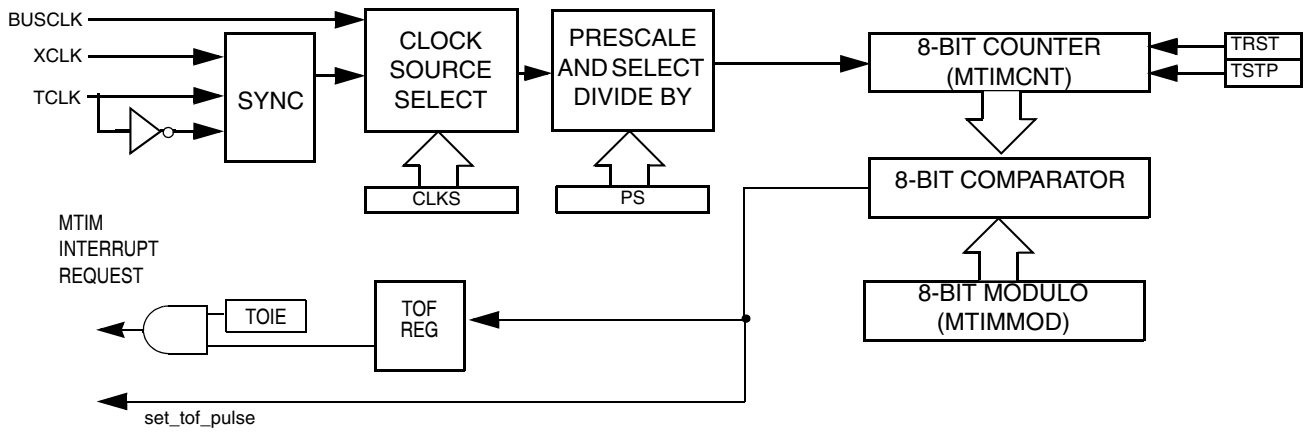

Figure 12-2. Modulo Timer (MTIM) Block Diagram

12.2 External Signal Description

The MTIM includes one external signal, TCLK, used to input an external clock when selected as the MTIM clock source. The signal properties of TCLK are shown in Table 12-1.

Table 12-1. Signal Properties

Signal	Function	I/O
TCLK	External clock source input into MTIM	I

The TCLK input must be synchronized by the bus clock. Also, variations in duty cycle and clock jitter must be accommodated. Therefore, the TCLK signal must be limited to one-fourth of the bus frequency.

The TCLK pin can be muxed with a general-purpose port pin. See the Pins and Connections chapter for the pin location and priority of this function.

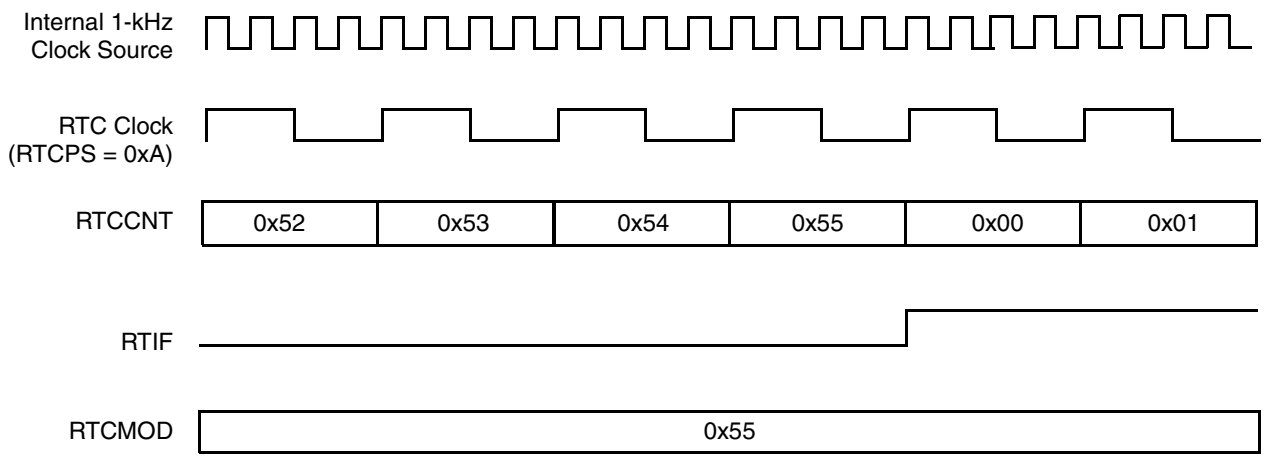

Figure 13-6. RTC Counter Overflow Example

In the example of Figure 13-6, the selected clock source is the 1-kHz internal oscillator clock source. The prescaler (RTCPS) is set to 0xA or divide-by-4. The modulo value in the RTCMOD register is set to 0x55. When the counter, RTCCNT, reaches the modulo value of 0x55, the counter overflows to 0x00 and continues counting. The real-time interrupt flag, RTIF, sets when the counter value changes from 0x55 to 0x00. A real-time interrupt is generated when RTIF is set, if RTIE is set.

13.5 Initialization/Application Information

This section provides example code to give some basic direction to a user on how to initialize and configure the RTC module. The example software is implemented in C language.

The example below shows how to implement time of day with the RTC using the 1-kHz clock source to achieve the lowest possible power consumption. Because the 1-kHz clock source is not as accurate as a crystal, software can be added for any adjustments. For accuracy without adjustments at the expense of additional power consumption, the external clock (ERCLK) or the internal clock (IRCLK) can be selected with appropriate prescaler and modulo values.

```
/* Initialize the elapsed time counters */
Seconds = 0;
Minutes = 0;
Hours = 0;
Days=0;

/* Configure RTC to interrupt every 1 second from 1-kHz clock source */
RTCMOD.byte = 0x00;
RTCSC.byte = 0x1F;

/*********************************************************************
Function Name : RTC_ISR
Notes : Interrupt service routine for RTC module.
*********************************************************************/
```

14.1.3 Block Diagram

Figure 14-2 shows the transmitter portion of the SCI.

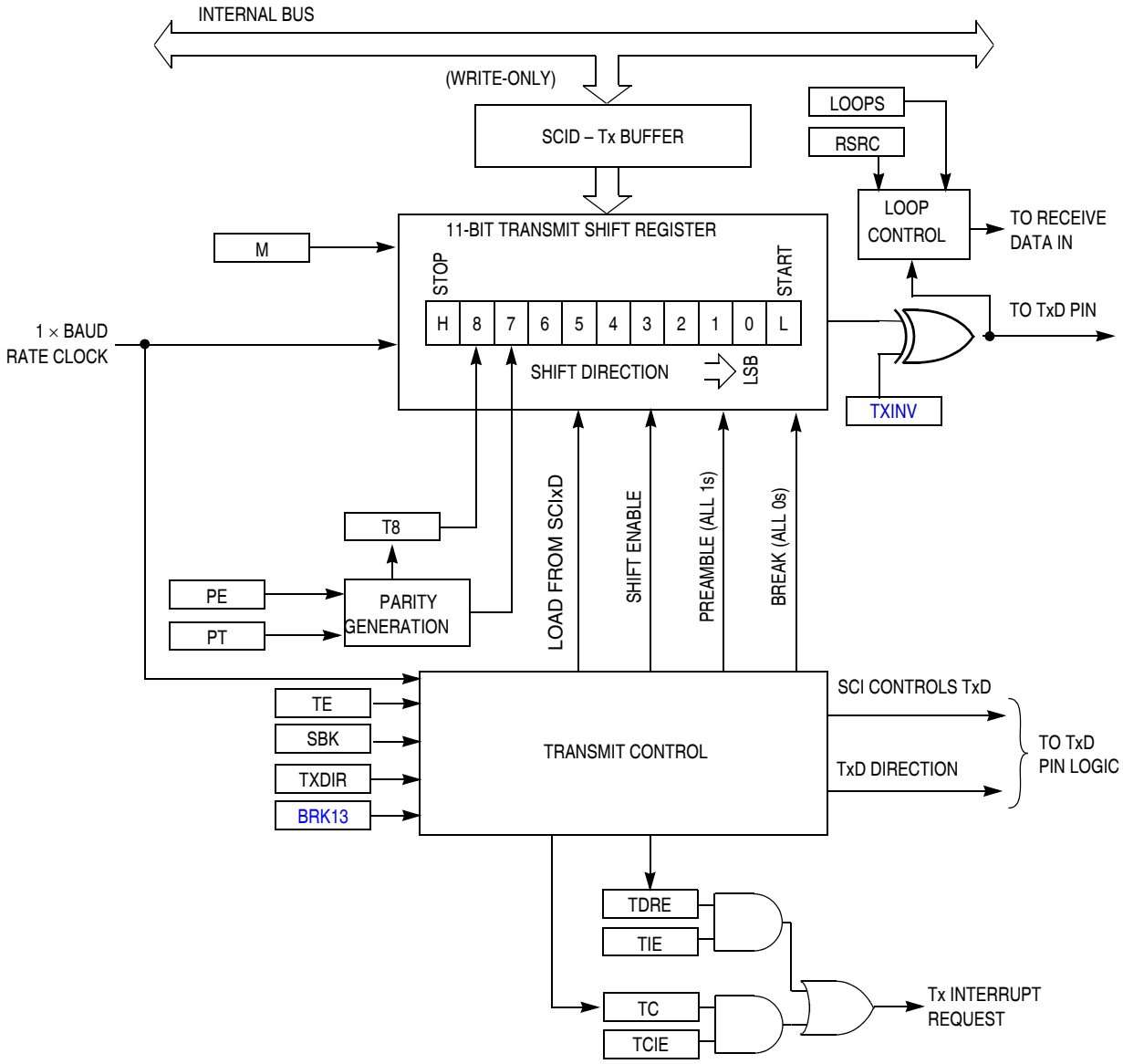

Figure 14-2. SCI Transmitter Block Diagram

Table 16-7. Mode, Edge, and Level Selection

CPWMS	MSnB:MSnA	ELSnB:ELSnA	Mode	Configuration
0	00	01	Input capture	Capture on rising edge only
		10		Capture on falling edge only
		11		Capture on rising or falling edge
	01	01	Output compare	Toggle output on compare
		10		Clear output on compare
		11		Set output on compare
	1X	10	Edge-aligned PWM	High-true pulses (clear output on compare)
		X1		Low-true pulses (set output on compare)
1	XX	10	Center-aligned PWM	High-true pulses (clear output on compare-up)
		X1		Low-true pulses (set output on compare-up)

16.3.5 TPM Channel Value Registers (TPMxCnVH:TPMxCnVL)

These read/write registers contain the captured TPM counter value of the input capture function or the output compare value for the output compare or PWM functions. The channel registers are cleared by reset.

	7	6	5	4	3	2	1	0
R W	Bit 15	14	13	12	11	10	9	Bit 8
Reset	0	0	0	0	0	0	0	0

Figure 16-13. TPM Channel Value Register High (TPMxCnVH)

	7	6	5	4	3	2	1	0
R W	Bit 7	6	5	4	3	2	1	Bit 0
Reset	0	0	0	0	0	0	0	0

Figure 16-14. TPM Channel Value Register Low (TPMxCnVL)

In input capture mode, reading either byte (TPMxCnVH or TPMxCnVL) latches the contents of both bytes into a buffer where they remain latched until the other half is read. This latching mechanism also resets

17.3 On-Chip Debug System (DBG)

Because HCS08 devices do not have external address and data buses, the most important functions of an in-circuit emulator have been built onto the chip with the MCU. The debug system consists of an 8-stage FIFO that can store address or data bus information, and a flexible trigger system to decide when to capture bus information and what information to capture. The system relies on the single-wire background debug system to access debug control registers and to read results out of the eight stage FIFO.

The debug module includes control and status registers that are accessible in the user's memory map. These registers are located in the high register space to avoid using valuable direct page memory space.

Most of the debug module's functions are used during development, and user programs rarely access any of the control and status registers for the debug module. The one exception is that the debug system can provide the means to implement a form of ROM patching. This topic is discussed in greater detail in Section 17.3.6, "Hardware Breakpoints."

17.3.1 Comparators A and B

Two 16-bit comparators (A and B) can optionally be qualified with the R/W signal and an opcode tracking circuit. Separate control bits allow you to ignore R/W for each comparator. The opcode tracking circuitry optionally allows you to specify that a trigger will occur only if the opcode at the specified address is actually executed as opposed to only being read from memory into the instruction queue. The comparators are also capable of magnitude comparisons to support the inside range and outside range trigger modes. Comparators are disabled temporarily during all BDC accesses.

The A comparator is always associated with the 16-bit CPU address. The B comparator compares to the CPU address or the 8-bit CPU data bus, depending on the trigger mode selected. Because the CPU data bus is separated into a read data bus and a write data bus, the RWAEN and RWA control bits have an additional purpose, in full address plus data comparisons they are used to decide which of these buses to use in the comparator B data bus comparisons. If RWAEN = 1 (enabled) and RWA = 0 (write), the CPU's write data bus is used. Otherwise, the CPU's read data bus is used.

The currently selected trigger mode determines what the debugger logic does when a comparator detects a qualified match condition. A match can cause:

- Generation of a breakpoint to the CPU
- Storage of data bus values into the FIFO
- Starting to store change-of-flow addresses into the FIFO (begin type trace)
- Stopping the storage of change-of-flow addresses into the FIFO (end type trace)

17.3.2 Bus Capture Information and FIFO Operation

The usual way to use the FIFO is to setup the trigger mode and other control options, then arm the debugger. When the FIFO has filled or the debugger has stopped storing data into the FIFO, you would read the information out of it in the order it was stored into the FIFO. Status bits indicate the number of words of valid information that are in the FIFO as data is stored into it. If a trace run is manually halted by writing 0 to ARM before the FIFO is full (CNT = 1:0:0:0), the information is shifted by one position and

A.7 Supply Current Characteristics

This section includes information about power supply current in various operating modes.

Table A-7. Supply Current Characteristics

#	C	Parameter	Symbol	V_{DD} (V)	Typ[1]	Max[2]	Unit
1	C	Run supply current[3] measured at (CPU clock = 4 MHz, f_{Bus} = 2 MHz)	RI_{DD}	5	1.4	3	mA
	C			3	1.3	2.5	mA
2	P	Run supply current[3] measured at (CPU clock = 16 MHz, f_{Bus} = 8 MHz)	RI_{DD}	5	4.7	7.5	mA
	C			3	4.6	7	mA
3	C	Run supply current[4] measured at (CPU clock = 32 MHz, f_{Bus} = 16MHz)	RI_{DD}	5	8.9	10	mA
	C			3	8.7	9.6	mA
4		Stop3 mode supply current					
		–40°C (C and M suffix)	$S3I_{DD}$	5	0.96	–	µA
	P	25°C (All parts)			1.3	–	µA
	P[5]	85°C (C suffix only)			16.9	35	µA
	P[5]	125°C (M suffix only)			84	150	µA
	C	–40°C (C and M suffix)		3	0.85	–	µA
	P	25°C (All parts)			1.2	–	µA
	P[5]	85°C (C suffix only)			14.8	30	µA
	P[5]	125°C (M suffix only)			75	130	µA